

Heisener.com

MT29F32G08ABEABM73A3WC1P

MT29F32G08ABEABM73A3WC1P Information

Part Number MT29F32G08ABEABM73A3WC1P

Manufacturer Micron Technology Inc. Integrated Circuits (ICs) Category

Memory

Description IC FLASH 32GBIT WAFER

Package

For the pricing/inventory/lead time, please contact

Website: https://www.heisener.com For Reference Only

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









MT29F32G08ABEABM73A3WC1P Specifications

Manufacturer Part Number	MT29F32G08ABEABM73A3WC1P
Manufacturer	Micron Technology Inc.
Category	Integrated Circuits (ICs)
	Memory
Package	Die
Series	-
Memory Type	Non-Volatile
Memory Format	FLASH
Technology	FLASH - NAND
Memory Size	32Gb (4G x 8)
Memory Interface	Parallel
Clock Frequency	-
Write Cycle Time - Word, Page	-
Access Time	-
Voltage - Supply	2.7 V ~ 3.6 V
Operating Temperature	$0^{\circ}\text{C} \sim 70^{\circ}\text{C} \text{ (TA)}$
Mounting Type	Surface Mount
Package / Case	Die
Supplier Device Package	Die
	Report errors?

MT29F32G08ABEABM73A3WC1P Guarantees



Ouality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MT29F32G08ABEABM73A3WC1P Payment Methods





















MT29F32G08ABEABM73A3WC1P Shipping Methods













If you have any question about MT29F32G08ABEABM73A3WC1P, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com